

# **Description**

The CTXS-6606S is a fast recovery diode of 600 V, 60 A. The maximum  $t_{\rm rr}$  of 35 ns is realized by optimizing a life-time control. The low thermal resistance package achieves high performance in terms of heat dissipation.

#### **Features**

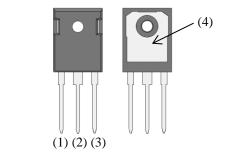
| • | Bare Lead Frame: Pb-free (RoHS Compliant) |
|---|-------------------------------------------|
| • | V <sub>RM</sub> 600 V                     |
| • | $I_{F(AV)}$ 60 A                          |
| • | V <sub>F</sub> 1.7 V                      |
| • | t <sub>rr</sub> 35 ns                     |
| • | Flammability: Equivalent to UL94V-0       |

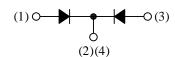
# **Applications**

- PFC Circuit
- Inverter Circuit

# **Package**

TO247-3L





- (1) Anode
- (2) Cathode
- (3) Anode
- (4) Cathode

Not to scale

## CTXS-6606S

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C

| Parameter                          | Symbol             | Conditions                                         | Rating     | Unit   |
|------------------------------------|--------------------|----------------------------------------------------|------------|--------|
| Nonrepetitive Peak Reverse Voltage | $V_{RSM}$          |                                                    | 600        | V      |
| Repetitive Peak Reverse Voltage    | $V_{RM}$           |                                                    | 600        | V      |
| Average Forward Current            | I <sub>F(AV)</sub> | See Figure 1 and Figure 2                          | 60         | A      |
| Surge Forward Current              | $I_{FSM}$          | Half cycle sine wave, positive side, 10 ms, 1 shot | 200        | A      |
| I <sup>2</sup> t Limiting Value    | $I^2t$             | $1 \text{ ms} \le t \le 10 \text{ ms}$             | 200        | $A^2s$ |
| Junction Temperature               | $T_J$              |                                                    | -40 to 150 | °C     |
| Storage Temperature                | $T_{STG}$          |                                                    | -40 to 150 | °C     |

## **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

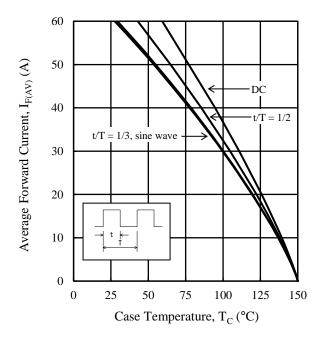
| Parameter                                         | Symbol               | Conditions                                                                       | Min. | Typ. | Max. | Unit |
|---------------------------------------------------|----------------------|----------------------------------------------------------------------------------|------|------|------|------|
| Engrand Voltage Duon                              | $V_{\mathrm{F}}$     | $T_J = 25  ^{\circ}\text{C}, I_F = 30  \text{A}$                                 | _    | _    | 1.7  | V    |
| Forward Voltage Drop                              |                      | $T_J = 100  ^{\circ}\text{C},  I_F = 30  \text{A}$                               |      | 1.3  |      | V    |
| Reverse Leakage Current                           | $I_R$                | $V_R = V_{RM}$                                                                   | _    | _    | 100  | μA   |
| Reverse Leakage Current<br>Under High Temperature | $H \cdot I_R$        | $V_R = V_{RM}$ , $T_J = 150$ °C                                                  | _    | _    | 30   | mA   |
| Reverse Recovery Time                             | t <sub>rr</sub>      | $I_F = I_{RP} = 500 \text{ mA},$<br>90% recovery point,<br>$T_J = 25 \text{ °C}$ | _    | _    | 35   | ns   |
| Thermal Resistance (1)                            | R <sub>th(J-C)</sub> |                                                                                  | _    | _    | 1.0  | °C/W |

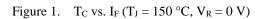
## **Mechanical Characteristics**

| Parameter                      | Conditions | Min.  | Тур. | Max.  | Unit |
|--------------------------------|------------|-------|------|-------|------|
| Heatsink Mounting Screw Torque |            | 0.686 | _    | 0.882 | N·m  |
| Package Weight                 |            | _     | 6.1  | _     | g    |

 $<sup>^{(1)}\,</sup>R_{\text{th (J-C)}}\,\text{is thermal resistance between junction and case.}$ 

## **Derating Curves**





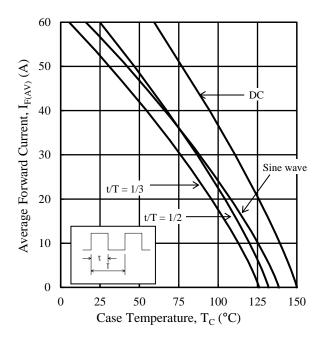


Figure 2.  $T_C$  vs.  $I_F$  ( $T_J = 150$  °C,  $V_R = 600$  V)

#### **Characteristic Curves**

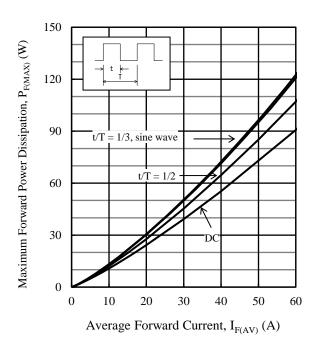


Figure 3.  $P_{F(MAX)}$  vs.  $I_{F(AV)}$  ( $T_J = 150$  °C)

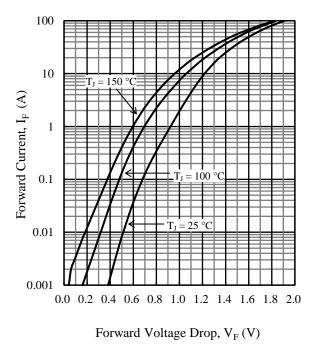


Figure 5. Typical Characteristics: V<sub>F</sub> vs. I<sub>F</sub>

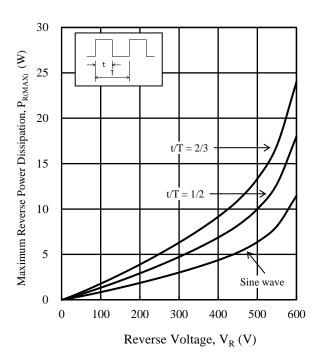


Figure 4.  $P_{R(MAX)}$  vs.  $V_R$  ( $T_J = 150$  °C)

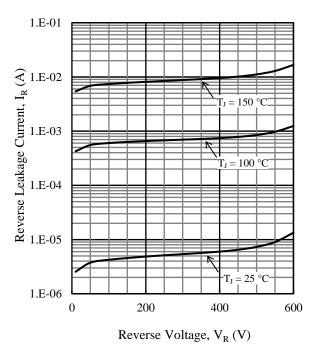


Figure 6. Typical Characteristics: V<sub>R</sub> vs. I<sub>R</sub>

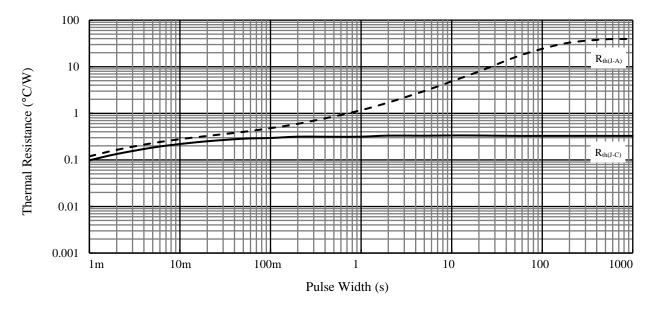
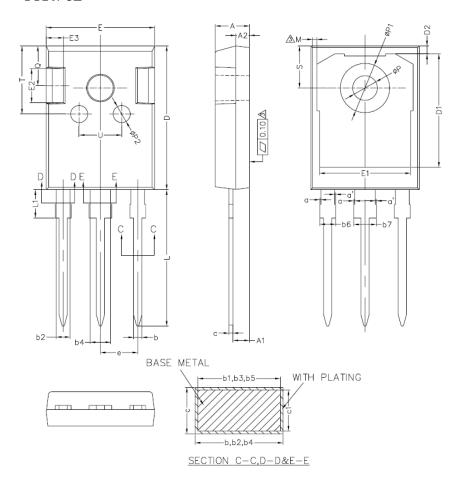


Figure 7. Typical Transient Thermal Resistance Characteristics

## **Physical Dimension**

#### • TO247-3L



| Symbol | Min.  | Typ.  | Max.  |
|--------|-------|-------|-------|
| A      | 4.90  | 5.00  | 5.10  |
| A1     | 2.31  | 2.41  | 2.51  |
| A2     | 1.90  | 2.00  | 2.10  |
| a      | 0     | _     | 0.15  |
| a'     | 0     | _     | 0.15  |
| b      | 1.16  | _     | 1.26  |
| b1     | 1.15  | 1.2   | 1.22  |
| b2     | 1.96  | _     | 2.06  |
| b3     | 1.95  | 2.00  | 2.02  |
| b4     | 2.96  | _     | 3.06  |
| b5     | 2.95  | 3.00  | 3.02  |
| b6     | _     | _     | 2.25  |
| b7     | _     | _     | 3.25  |
| С      | 0.59  | _     | 0.66  |
| c1     | 0.58  | 0.60  | 0.62  |
| D      | 20.90 | 21.00 | 21.10 |
| D1     | 16.25 | 16.55 | 16.85 |
| D2     | 1.05  | 1.20  | 1.35  |
| Е      | 15.70 | 15.80 | 15.90 |
| E1     | 13.10 | 13.30 | 13.50 |
| E2     | 4.90  | 5.00  | 5.10  |
| E3     | 2.40  | 2.50  | 2.60  |
| e      | 5.34  | 5.44  | 5.54  |
| L      | 19.80 | 19.92 | 20.10 |
| L1     | _     | _     | 4.30  |
| M      | 0.35  | _     | 0.95  |
| P      | 3.50  | 3.60  | 3.70  |
| P1     | 7.00  | _     | 7.40  |
| P2     | 2.40  | 2.50  | 2.60  |
| Q      | 5.60  | _     | 6.00  |
| S      | 6.05  | 6.15  | 6.25  |
| T      | 9.80  | _     | 10.20 |
| U      | 6.00  |       | 6.40  |
|        |       |       |       |

#### **NOTES:**

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 260 °C / 10 s, 1 time

Soldering Iron:  $350 \, ^{\circ}\text{C} \, / \, 3.5 \, \text{s}, \, 1 \, \text{time}$ 

Soldering should be at a distance of at least 1.5 mm from the body of the product.

## **Marking Diagram**

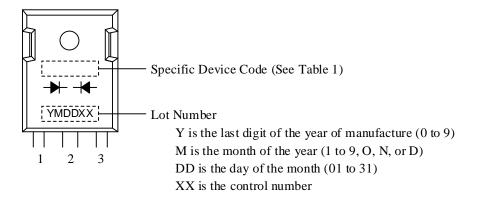


Table 1. Specific Device Code

| Specific Device Code | Part Number |
|----------------------|-------------|
| XS6606               | CTXS-6606S  |

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